FAIRCHILD

SEMICONDUCTOR®

SSN1N45B **450V N-Channel MOSFET**

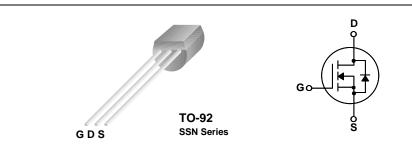
General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for electronic ballasts based on half bridge configuration.

Features

- + 0.5A, 450V, $R_{DS(on)}$ = 4.25 Ω @V_{GS} = 10 V + Low gate charge (typical 6.5 nC)
- Low Crss (typical 6.5 pF)
- 100% avalanche tested
- Improved dv/dt capability
- Gate-Source Voltage ± 50V guaranteed



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

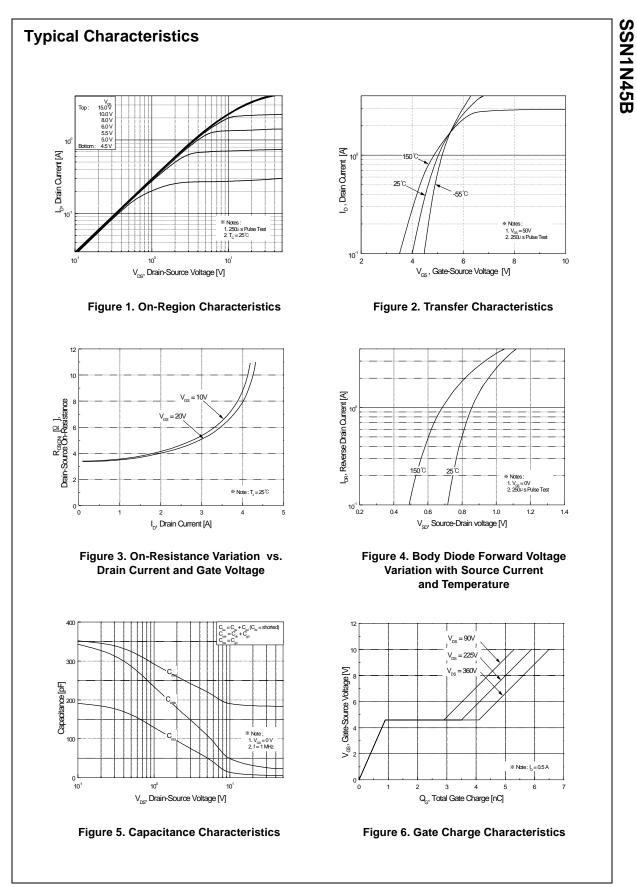
Symbol	Parameter Drain-Source Voltage		SSN1N45B	Units V
V _{DSS}			450	
I _D	Drain Current - Continuous (T _C = 25	°C)	0.5	Α
	- Continuous (T _C = 10	D°C)	0.32	А
I _{DM}	Drain Current - Pulsed	(Note 1)	4.0	A
V _{GSS}	Gate-Source Voltage		± 50	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	108 0.5	mJ A
I _{AR}	Avalanche Current	(Note 1)		
E _{AR}	Repetitive Avalanche Energy	(Note 1)	0.25	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		5.5	V/ns
P _D	Power Dissipation ($T_A = 25^{\circ}C$)		0.9	W
	Power Dissipation ($T_L = 25^{\circ}C$)		2.5	W
	- Derate above 25°C		0.02	W/°C
T _J , T _{stg}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering 1/8" from case for 5 seconds	g purposes,	300	°C

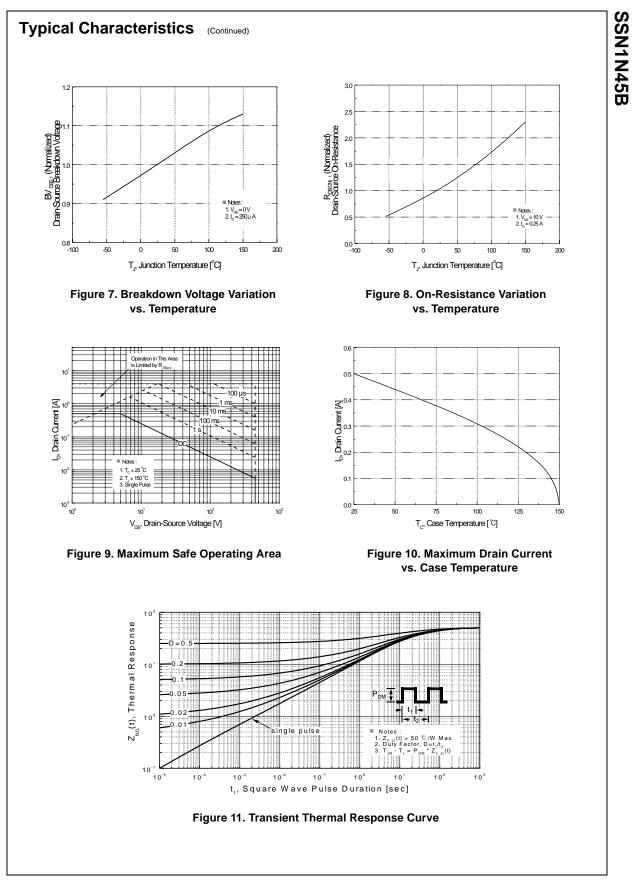
Thermal Characteristics

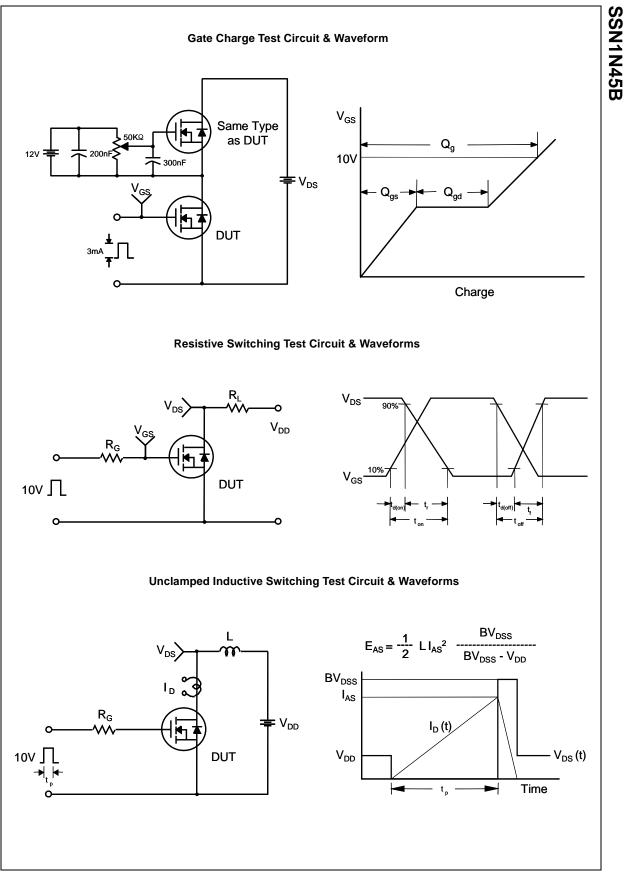
Symbol	Parameter		Тур	Max	Units
$R_{ extsf{ heta}JL}$	Thermal Resistance, Junction-to-Lead	(Note 6a)		50	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient	(Note 6b)		140	°C/W

SSN1N45B

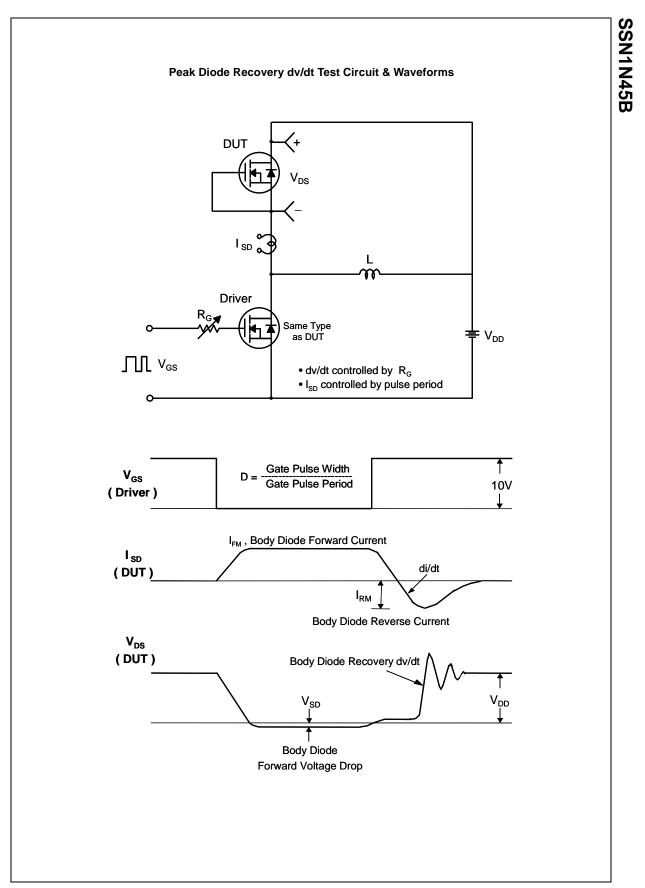
Symbol	Symbol Parameter Test Conditions				Max	Units
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	450			V
ΔBV _{DSS} / ΔΤ.	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu$ A, Referenced to 25°C		0.5		V/°C
		V _{DS} = 450 V, V _{GS} = 0 V			10	μA μA ηA nA nA NA NA NA NA N S PF pF pF nRs ns ns ns nC nC A A
200	Zero Gate Voltage Drain Current	$V_{DS} = 360 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$			100	
GSSF	Gate-Body Leakage Current, Forward	V _{GS} = 50 V, V _{DS} = 0 V			100	nA
GSSR	Gate-Body Leakage Current, Reverse	V_{GS} = -50 V, V_{DS} = 0 V			-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.3	3.0	3.7	V
	C C C C C C C C C C C C C C C C C C C	3.5	4.2	4.9	V	
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{DS} = V_{GS}, I_D = 250 \text{ mA}$ $V_{GS} = 10 \text{ V}, I_D = 0.25 \text{ A}$		3.4	4.25	Ω
JFS	Forward Transconductance	V _{DS} = 50 V, I _D = 0.25 A		0.7		S
_						
Dynam C _{iss}	ic Characteristics	N/ 05.1/1/ 0.1/		185	240	nF
C _{oss}	Output Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$		29	40	
C _{rss}	Reverse Transfer Capacitance	f = 1.0 MHz		6.5	8.5	
d(on)	ng Characteristics Turn-On Delay Time	V _{DD} = 225 V, I _D = 0.5 A,		7.5	25	
r	Turn-On Rise Time			21	50	
d(off)	Turn-Off Delay Time	$R_{G} = 25 \Omega$		23	55	ns
f	Turn-Off Fall Time	(Note 4,5)		36	80	ns
ე _g	Total Gate Charge	V _{DS} = 360 V, I _D = 0.5 A,		6.5	8.5	nC
ວ _{gs}	Gate-Source Charge	$V_{GS} = 10 V$		0.9		nC
ຊ _{gd}	Gate-Drain Charge	(Note 4,5)		3.2		nC
Drain S	ource Diode Characteristics ar	ad Maximum Patings				
s	Maximum Continuous Drain-Source Dic				0.5	Α
SM	Maximum Pulsed Drain-Source Diode F				4.0	
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 0.5 \text{ A}$			1.4	V
rr	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 0.5 \text{ A},$		102		ns
ື ຊ _{rr}	Reverse Recovery Charge	$dI_{F}/dt = 100 \text{ A/}\mu\text{s}$ (Note 4)		0.26		μC
btes: Repetitive R L = 75mH, I _J $I_{SD} \le 0.5A$, Pulse Test : Essentially in a) Reference b) When mo	Active the second seco	a still air environment				μο

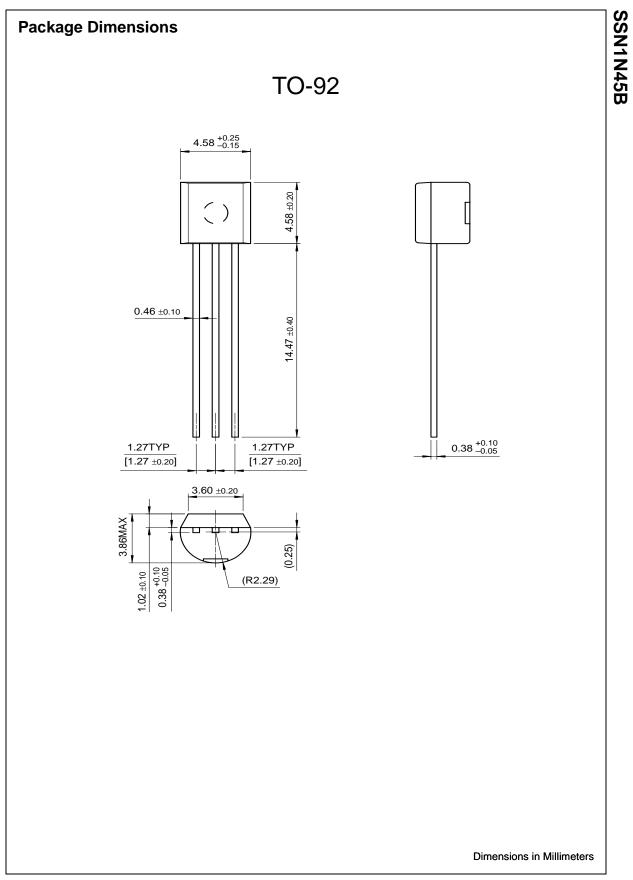






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Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.



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General description

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Product status/pricing/packaging







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Pricing* Product Product status **Pb-free Status** Package type Leads Packing method Package Marking Convention**

SSN1N45BBU	Full Production	Full Production	\$0.466	<u>TO-92</u>	3	BULK	<u>Line 1:</u> 1N45B <u>Line 2:</u> 3
SSN1N45BTA	Full Production	Full Production	\$0.394	<u>TO-92</u>	3	AMMO	<u>Line 1:</u> 1N45B <u>Line 2:</u> 3

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